BGA / SMT Rework DATA

ERSA systems for safe and controlled IR Reflow



Fig.: 0IR550A and 0PL550A (monitor not included in the delivery)

Precision and control - to know, to see, to succeed!

With thousands of systems already sold, the ERSA IR 500 A has become well established in industry. In the meantime, the ERSA Rework Family has grown!

The microprocessor controlled rework system IR 550 A is a further development of the IR 500 A. More powerful heating elements, microprocessor controlled temperature profiles and a non-contacting heat sensor are the outstanding features of this unit. The professional user is also offered reproducible soldering qualities and process documentation for single components with the PC compatible software IRSoft.

With the reflow process camera ERSA RPC 550 A, it is now possible to directly watch the formation of BGA soldering joints during reflow. The RPC 550 A consits of a 72 x motor zoom camera with integrated LED-ringlight. In combination with the IR-systems, ERSA offers the chance for safe and controlled BGA / SMT rework

The PL 550 A is a high-precision placement system for a wide range of SMT-components with dimensions ranging from 1 x 1 mm (0.04 - 0.04") to 40 x 40 mm (1.6 x 1.6").

A high resolution PAL CCD-color camera allows precise and easiest component alignment, and the motorized





PBGA during reflow

72 x zoom together with two zoom presettings make the system handling even more comfortable. The motorized z-axis and the automatically switching "pick-nplace" mechanism ensure best functionality.

Additionally, the PL 550 A unit is equipped with a reflow process camera module. This module allows the visual process control during the soldering process - also with soldering joints hidden under the component.

The most important pre-requisites for successful SMT rework are the knowledge about soldering processes and the ability to see how the soldering joint forms.

Thus, the combinations of IR 550 A and RPC 550 A or IR 550 A and PL 550 A are the ultimate form of process control for BGA / SMT rework.



ERSA product range

Soldering tools

NEW DIMENSION

- Soldering / desoldering stations
- SMD-Equipment
- Accessories

PROFI-LINE

- Hand soldering tools
- Battery-powered / gas soldering irons
- Solder baths
- · Special tools

BGA/SMT-Rework

- IR Rework Center
- Placing systems · Reflow process
- camera

CLEAN-AIR

Soldering systems

- Wave soldering machines
- Reflow soldering machines
- Selective soldering machines
- Process optimization software

Inspection systems

- ERSASCOPE
- ImageDoc Software

Other services

- Know-how seminars
- In-House trainings
- Test soldering
- Installation and maintenance assistance
- Process support

CSP during reflow

BGA / SMT Rework DATA

ERSA systems for safe and controlled IR Reflow

Features, technical description:

IR Rework System

Components	IR 500 A	IR 550 A			
Emitters					
 Wavelength 	dark IR technology, 2 - 8 μm	dark IR technology, 2 - 8 µm			
 Heating power Total Top radiator Bottom radiator 	600 W ceramics, 200 W ceramics, 400 W	1600 W ceramic emitter, 4 x 200 W ceramics, 2 x 400 W			
 Dimensions Top radiator Bottom radiator 	20 x 20 mm to 60 x 60 mm 120 x 120 mm	20 x 20 mm to 60 x 60 mm 125 x 250 mm			
 Bottom radiator cover 	stainless steel grid	heat-resistant glass pane			
Temperature control	discontinuous emitter control	true "Closed Loop" control			
Control system	analog	digital			
Profiles	manual, 1 profile	automatic, 4 profiles			
Temperature recording	by K-type thermocouple	non-contact infrared sensor			
Accessories					
 Vacuum pipette 	included	included			
 Cooling fan 	option	standard and option			
 Documentation 	single channel via MicroCon	two-channel and process data monitoring			
PC software	not included	included			
 Soldering station 	MicroCon 60 iA with Tech tool	Digital 2000 A with Tech tool			

Reflow Process Camera RPC 550 A

soldering joints is also possible)

soldering joint illumination

external keyboard

software

Two pre-set, selectable zooms

systems with height adjustment

High-precision PCB table

Visual process control (monitoring of hidden

Freely adjustable 72 x monitor zoom camera

Easy setting of zoom, focus and ring light via

Direct cooling of the component after soldering

Solid base plate for the installation of IR rework

Interface for monitor or PC with documentation

Integrated, dimmable LED ring light for optimum

High Precision Placement System PL 550 A

- Placement system for high channel SMT components up to 40 x 40 mm
- Placement accuracy <± 10 µm
- High-precision X-Y PCB table
- High-contrast, dimmable LED illumination of component pins and pads
- Automatically switching vacuum for safe component placement
- Integrated, automatically switching reflow process camera with dimmable LED ring light (see RPC 550 A)
- Comfortable adjustment of zoom, focus, placement head and ring light via external keyboard

Monitor recommendation:

The ERSA PL and RPC systems are equipped with high-resolution PAL CCD cameras. The systems can only be used together with a PAL compatible or Multisync color monitor. Best visualisation will be reached with high-resolution tube monitors (horizontal resolution ≥ 470 TV lines). A b/w monitor is unsuitable for this application. It is possible to connect a PC frame grabber card.

Order nos.: (for 230 V executions)	(order nos. for	r 115	V executions on demand)
		-	

IR 550 A:		PL 550 A:	
0IR550A	Microprozessor controlled rework system (incl. ERSA IRSoft and soldering station;	0PL550A	Precision placement system with reflow process camera
	without X-Y PCB table)	0PL550AU	Precision placement system, retrofitable
0IR5500-01	X-Y PCB table (not applicable with PL or		with Reflow Process Camera
	RPC 550 A)		(0VSRPC-UKIT)
0IR5500-02	K-type thermocouple and attachment kit	0VSRPC-UKIT	Reflow Process Camera retrofit kit for
	(option)		precision placement system 0PL550AU
0IR5500-13	Cooling fan for PCBs, ø 120 mm (option)	0PL500A-SPC	Split Optik Cassette (recommended option)
		0VSID100	ERSA IDView software and Falcon Frame-
IR 500 A:			grabber (recommended option)
0IR500AS	Rework system incl. digital soldering station	0PL500A-LP01	PCB support (option)
0IR5500-01	X-Y PCB table (not necessary in		
	combination with PL or RPC 550 A)	RPC 550 A:	
0IR4500-06	Cooling fan for PCBs, ø 80 mm	0VSRPC550A	Reflow Process Camera (incl. cooling fan)
	(recommended option)	0VSID100	ERSA IDView software and Falcon
0PH100	PCB holder for mobile phones in combina-		Framegrabber (recommended option)
	tion with the X-Y PCB table (option)	0PL500A-LP01	PCB support (option)





PL 550 A (detail)



RPC 550 A (detail)

Asia:

ERSA Asia Pacific A division of Kurtz Far East Ltd. Suite 3505. 35/F China Resources Building 26 Harbour Road Wan Chai Hong Kong Tel: (+852) 2331-2232 Fax: (+852) 2758-7749 e-mail: kurtz@kfe.com.hk http://www.ersa.com

Part A, 2/F., 207 Tai Gu Road Wai Gao Qiao Free Trade Zone Pudong Shanghai 200131 China Phone: (+86) 21 5868 0207-9 Fax: (+86) 21 5868 0217 e-mail: kurtz@kurtz.com.cn http://www.ersa.com

USA: ERSA Inc. Pilgrim Road 1779 Plymouth, WI 53073 U.S.A. Tel: (+1) 800 363 3772 Fax: (+1) 920 893 3322 e-mail: info@ersainc.com http://www.ersa.com

